

## OptiMOS™ - 6 Power-Transistor



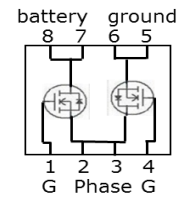
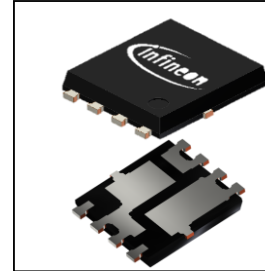
### Product Summary

|                  |     |    |
|------------------|-----|----|
| $V_{DS}$         | 40  | V  |
| $R_{DS(on),max}$ | 4.5 | mΩ |
| $I_D$            | 60  | A  |

### Features

- OptiMOS™ - power MOSFET for automotive applications
- Half-Bridge - N-channel - Enhancement mode - Logic Level
- AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested

PG-TDSON-8-57



| Type             | Package       | Marking  |
|------------------|---------------|----------|
| IAUC60N04S6L045H | PG-TDSON-8-57 | 6N04L045 |

Maximum ratings per channel, at  $T_J=25^\circ\text{C}$ , unless otherwise specified

| Parameter                                    | Symbol         | Conditions                                                                           | Value        | Unit |
|----------------------------------------------|----------------|--------------------------------------------------------------------------------------|--------------|------|
| Drain current                                | $I_D$          | $V_{GS}=10\text{V}$ ,<br>Chip Limitation <sup>1,2)</sup>                             | 80           | A    |
|                                              |                | $V_{GS}=10\text{V}$ ,<br>DC current <sup>3)</sup>                                    | 60           |      |
|                                              |                | $T_a=85^\circ\text{C}$ , $V_{GS}=10\text{V}$ ,<br>$R_{thJA}$ on 2s2p <sup>2,4)</sup> | 18           |      |
| Pulsed drain current <sup>2)</sup>           | $I_{D,pulse}$  | $T_C=25^\circ\text{C}$ , $t_p=100\mu\text{s}$                                        | 193          |      |
| Avalanche energy, single pulse <sup>2)</sup> | $E_{AS}$       | $I_D=12\text{A}$ , $R_{g,min}=25\Omega$                                              | 53           | mJ   |
| Avalanche current, single pulse              | $I_{AS}$       | $R_{g,min}=25\Omega$                                                                 | 12           | A    |
| Gate source voltage                          | $V_{GS}$       | -                                                                                    | $\pm 16$     | V    |
| Power dissipation                            | $P_{tot}$      | $T_C=25^\circ\text{C}$                                                               | 52           | W    |
| Operating and storage temperature            | $T_J, T_{stg}$ | -                                                                                    | -55 ... +175 | °C   |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Thermal characteristics<sup>2)</sup>**

|                                                      |            |   |   |    |     |     |
|------------------------------------------------------|------------|---|---|----|-----|-----|
| Thermal resistance, junction - case                  | $R_{thJC}$ | - | - | -  | 2.9 | K/W |
| Thermal resistance, junction - ambient <sup>4)</sup> | $R_{thJA}$ | - | - | 35 | -   |     |

**Electrical characteristics, at  $T_j=25^\circ\text{C}$ , unless otherwise specified**
**Static characteristics**

|                                  |               |                                                     |     |     |     |            |
|----------------------------------|---------------|-----------------------------------------------------|-----|-----|-----|------------|
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=1mA$                                | 40  | -   | -   | V          |
| Gate threshold voltage           | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=13\mu A$                        | 1.2 | 1.6 | 2.0 |            |
| Zero gate voltage drain current  | $I_{DSS}$     | $V_{DS}=40V, V_{GS}=0V, T_j=25^\circ\text{C}$       | -   | -   | 1   | $\mu A$    |
|                                  |               | $V_{DS}=40V, V_{GS}=0V, T_j=125^\circ\text{C}^{2)}$ | -   | -   | 10  |            |
| Gate-source leakage current      | $I_{GSS}$     | $V_{GS}=16V, V_{DS}=0V$                             | -   | -   | 100 | nA         |
| Drain-source on-state resistance | $R_{DS(on)}$  | $V_{GS}=4.5V, I_D=30A$                              | -   | 5.2 | 6.0 | m $\Omega$ |
|                                  |               | $V_{GS}=10V, I_D=30A$                               | -   | 3.7 | 4.5 |            |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

#### Dynamic characteristics<sup>2)</sup>

|                              |              |                                                  |   |     |      |    |
|------------------------------|--------------|--------------------------------------------------|---|-----|------|----|
| Input capacitance            | $C_{iss}$    | $V_{GS}=0V, V_{DS}=25V, f=1MHz$                  | - | 874 | 1136 | pF |
| Output capacitance           | $C_{oss}$    |                                                  | - | 250 | 325  |    |
| Reverse transfer capacitance | $C_{rss}$    |                                                  | - | 19  | 29   |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD}=20V, V_{GS}=10V, I_D=60A, R_G=3.5\Omega$ | - | 2   | -    | ns |
| Rise time                    | $t_r$        |                                                  | - | 1   | -    |    |
| Turn-off delay time          | $t_{d(off)}$ |                                                  | - | 9   | -    |    |
| Fall time                    | $t_f$        |                                                  | - | 4   | -    |    |

#### Gate Charge Characteristics<sup>2)</sup>

|                       |               |                                                 |   |     |     |    |
|-----------------------|---------------|-------------------------------------------------|---|-----|-----|----|
| Gate to source charge | $Q_{gs}$      | $V_{DD}=32V, I_D=60A, V_{GS}=0 \text{ to } 10V$ | - | 2.9 | 3.7 | nC |
| Gate to drain charge  | $Q_{gd}$      |                                                 | - | 3.0 | 4.5 |    |
| Gate charge total     | $Q_g$         |                                                 | - | 14  | 19  |    |
| Gate plateau voltage  | $V_{plateau}$ |                                                 | - | 3.3 | -   | V  |

#### Reverse Diode

|                                                |               |                                        |   |      |     |    |
|------------------------------------------------|---------------|----------------------------------------|---|------|-----|----|
| Diode continuous forward current <sup>2)</sup> | $I_S$         | $T_C=25^\circ C$                       | - | -    | 60  | A  |
| Diode pulse current <sup>2)</sup>              | $I_{S,pulse}$ | $T_C=25^\circ C, t_p=100\mu s$         | - | -    | 193 |    |
| Diode forward voltage                          | $V_{SD}$      | $V_{GS}=0V, I_F=30A, T_J=25^\circ C$   | - | 0.85 | 1.1 | V  |
| Reverse recovery time <sup>2)</sup>            | $t_{rr}$      | $V_R=20V, I_F=50A, di_F/dt=100A/\mu s$ | - | 22   | -   | ns |
| Reverse recovery charge <sup>2)</sup>          | $Q_{rr}$      |                                        | - | 9    | -   | nC |

<sup>1)</sup> Practically the current is limited by overall system design including customer specific PCB.

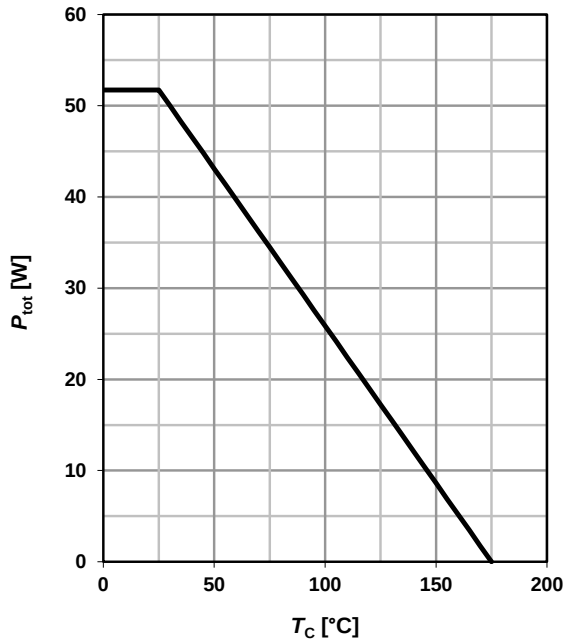
<sup>2)</sup> The parameter is not subject to production test - specified by design.

<sup>3)</sup> The product can operate at specified current based on best practice to minimize electromigration at the solder joint. For rare events and inrush currents the value may be exceeded.

<sup>4)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

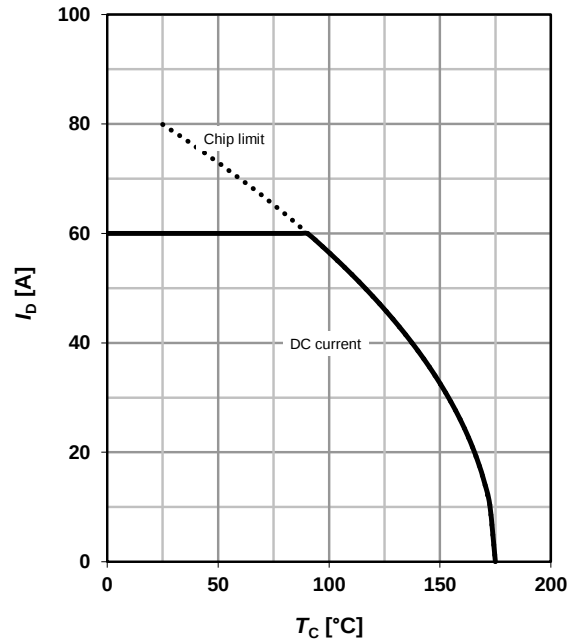
### 1 Power dissipation

$$P_{\text{tot}} = f(T_C); V_{\text{GS}} = 10 \text{ V}$$



### 2 Drain current

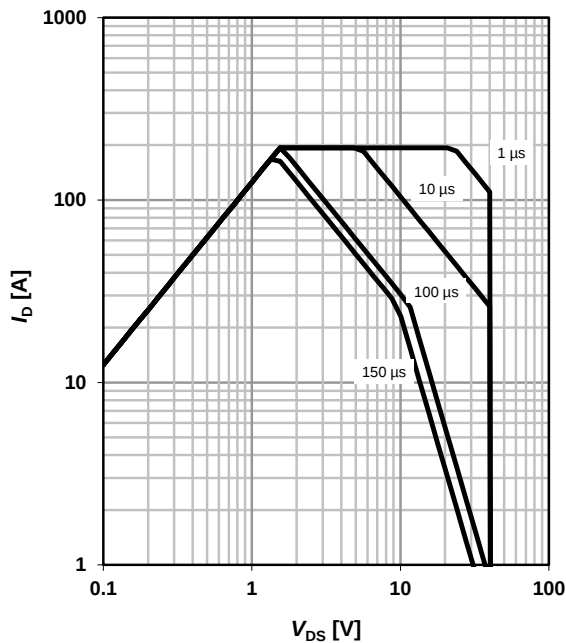
$$I_D = f(T_C); V_{\text{GS}} = 10 \text{ V}$$



### 3 Safe operating area

$$I_D = f(V_{\text{DS}}); T_C = 25^\circ\text{C}; D = 0$$

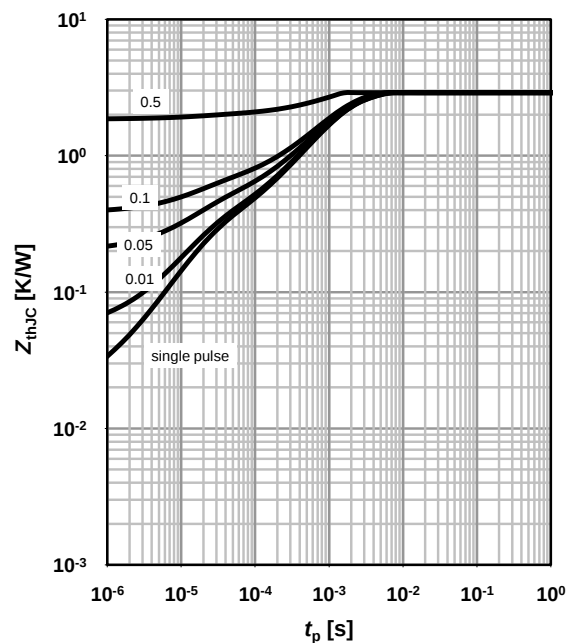
parameter:  $t_p$



### 4 Max. transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

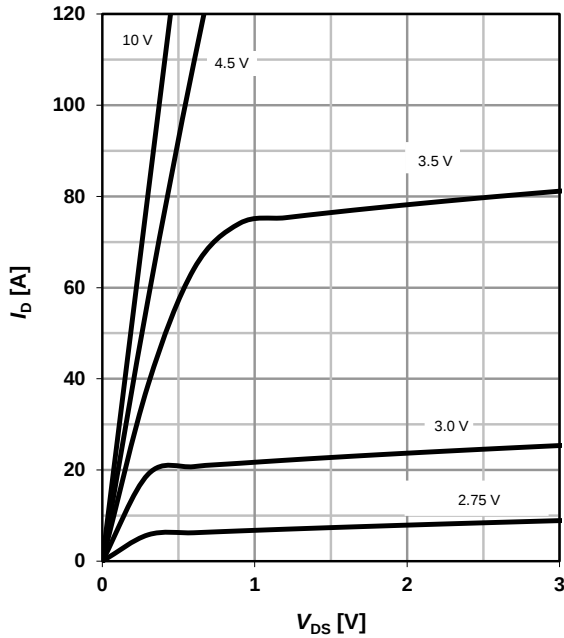
parameter:  $D = t_p/T$



### 5 Typ. output characteristics

$$I_D = f(V_{DS}); T_j = 25^\circ\text{C}$$

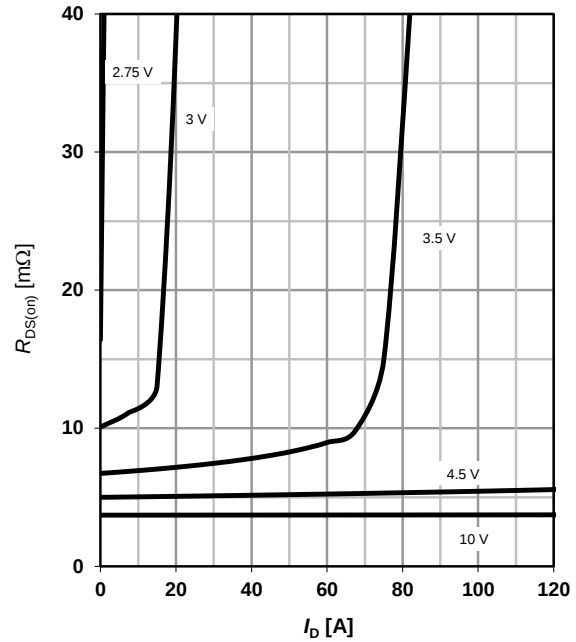
parameter:  $V_{GS}$



### 6 Typ. drain-source on-state resistance

$$R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$$

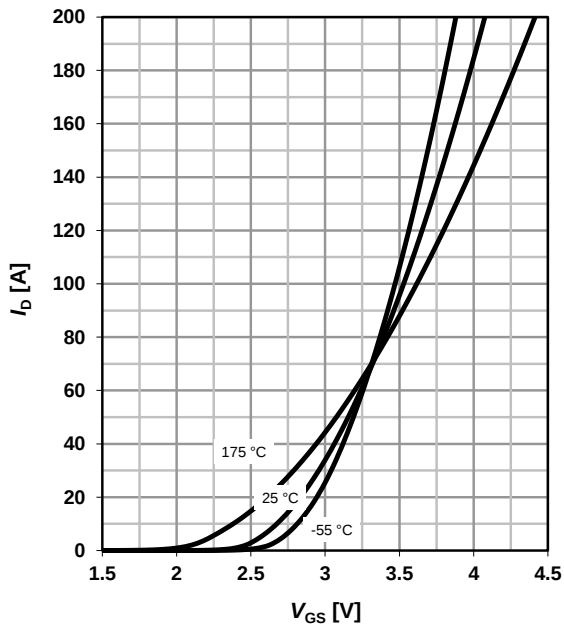
parameter:  $V_{GS}$



### 7 Typ. transfer characteristics

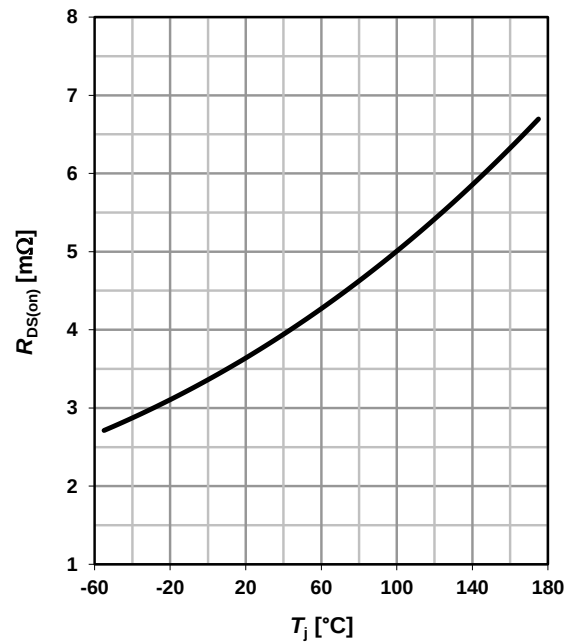
$$I_D = f(V_{GS}); V_{DS} = 6\text{V}$$

parameter:  $T_j$



### 8 Typ. drain-source on-state resistance

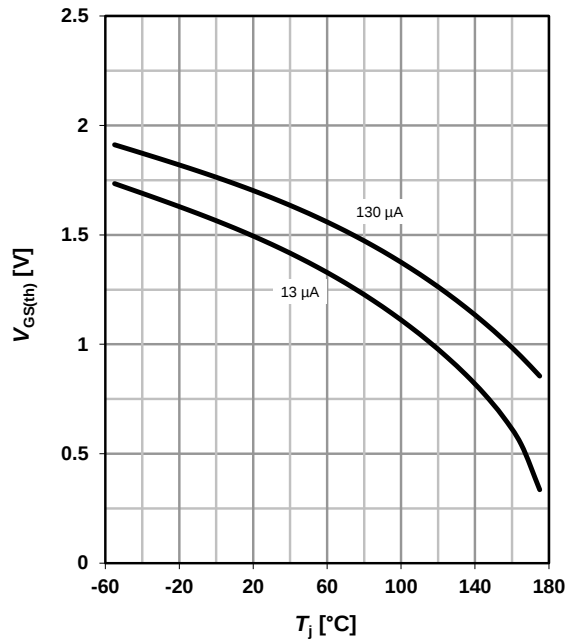
$$R_{DS(on)} = f(T_j); I_D = 30\text{ A}; V_{GS} = 10\text{ V}$$



### 9 Typ. gate threshold voltage

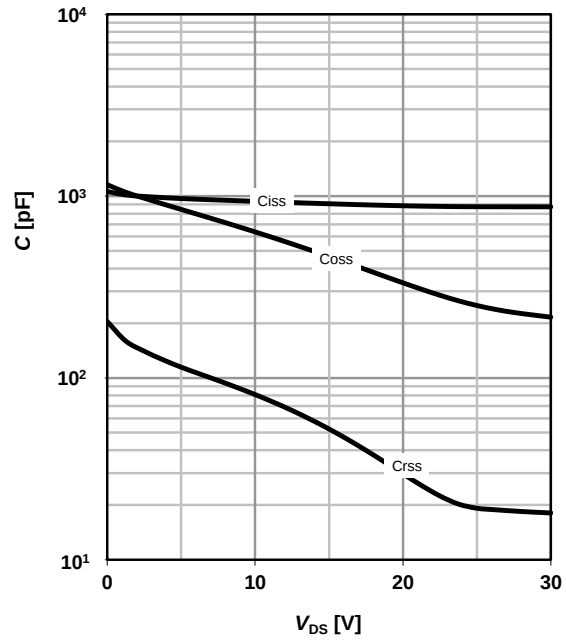
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$$

parameter:  $I_D$



### 10 Typ. capacitances

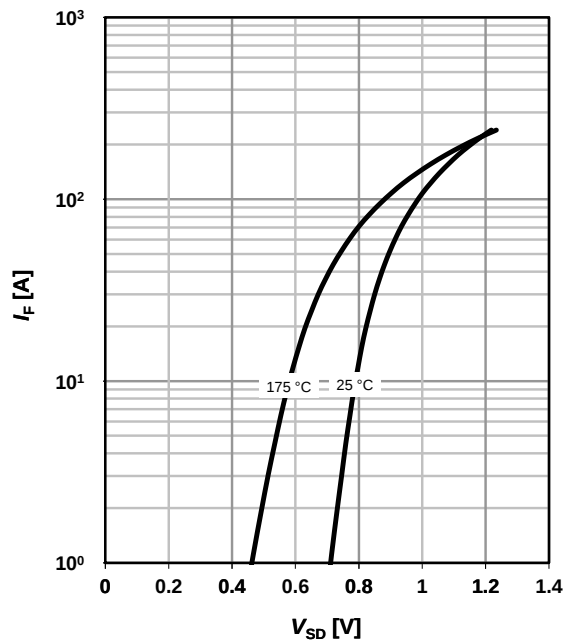
$$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$$



### 11 Typical forward diode characteristics

$$I_F = f(V_{SD})$$

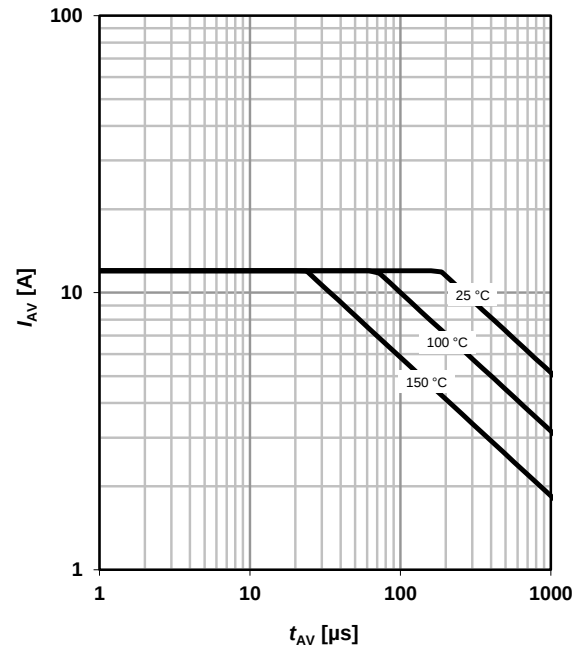
parameter:  $T_j$



### 12 Avalanche characteristics

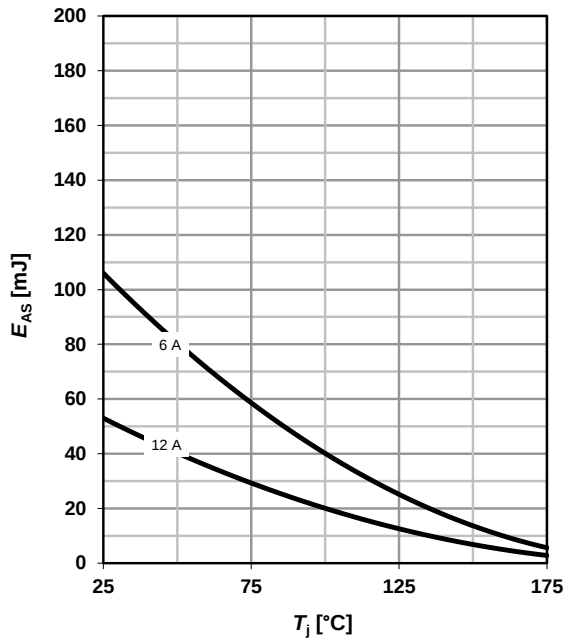
$$I_{AS} = f(t_{AV})$$

parameter:  $T_{j(start)}$



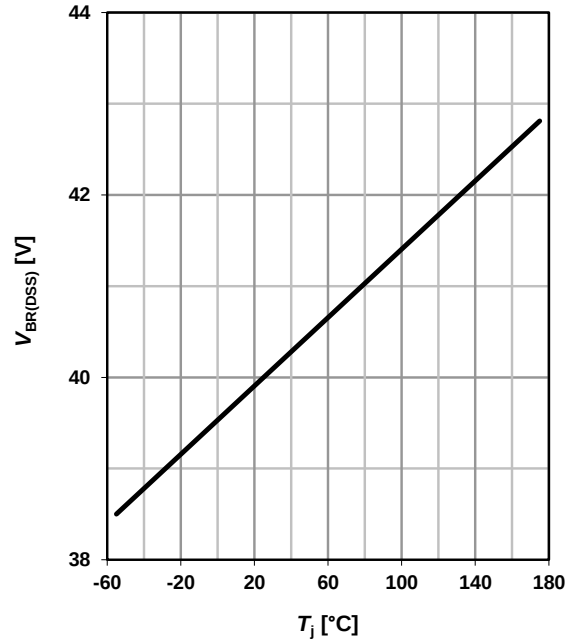
### 13 Avalanche energy

$$E_{AS} = f(T_j)$$



### 14 Drain-source breakdown voltage

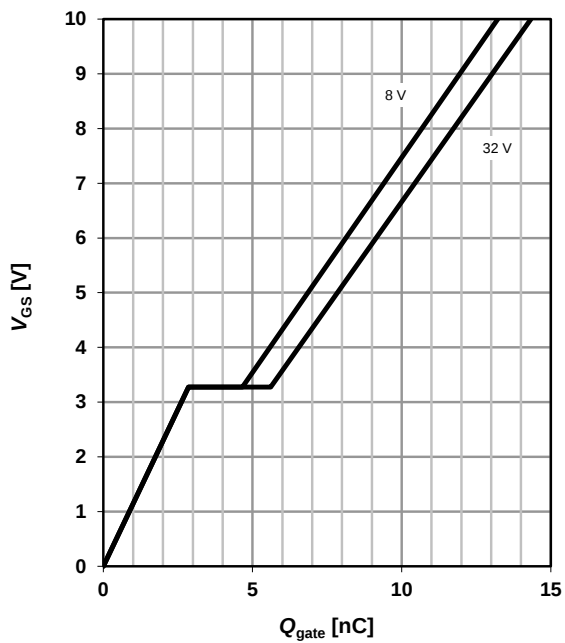
$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$



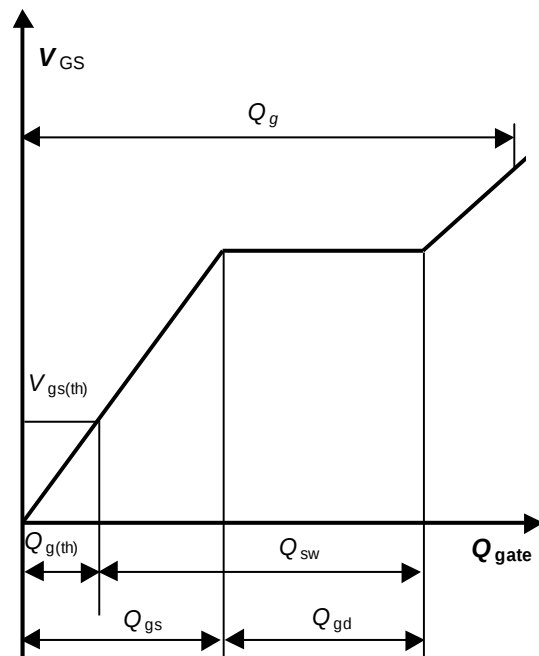
### 15 Typ. gate charge

$$V_{GS} = f(Q_{gate}); I_D = 60 \text{ A pulsed}$$

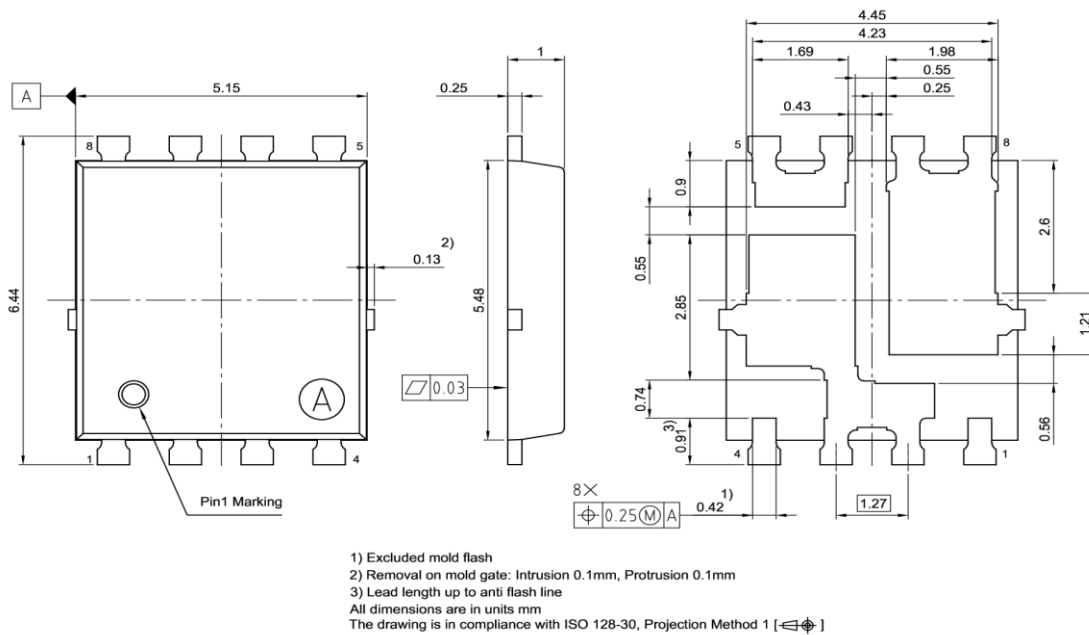
parameter:  $V_{DD}$



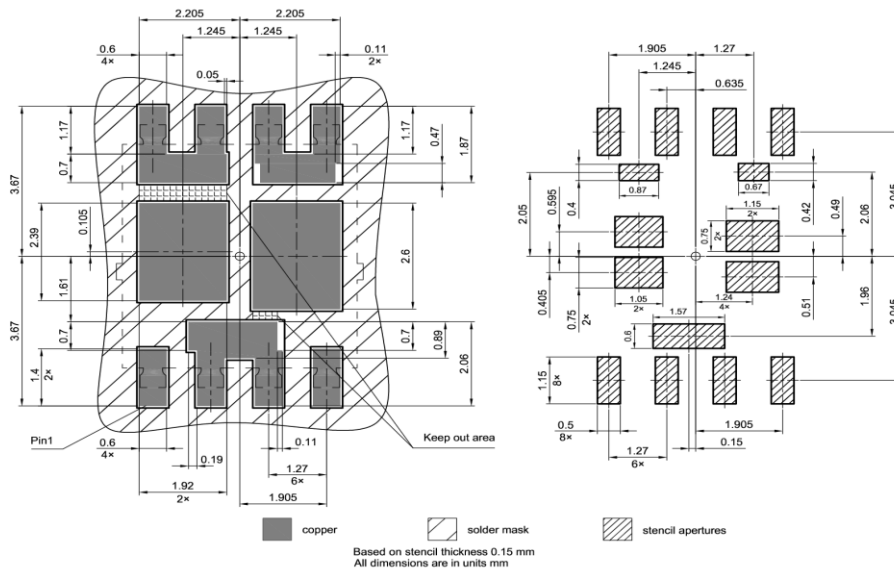
### 16 Gate charge waveforms



## PG-TDSON-8: Outline

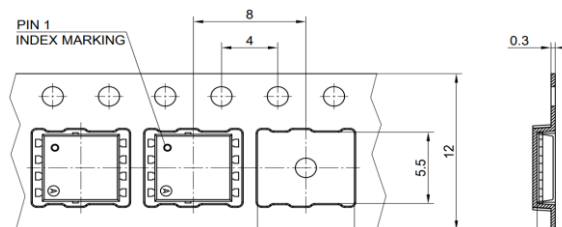


## Footprint



Dimensions in mm

## Packaging



**Published by**  
**Infineon Technologies AG**  
**81726 Munich, Germany**

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Revision History

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| Version      | Date       | Changes                                                               |
|--------------|------------|-----------------------------------------------------------------------|
| Revision 1.0 | 22/09/2020 | Final Datasheet                                                       |
| Revision 1.1 | 19/02/2025 | Updated Is, Is,pulse, Vsd values, plot 11, plot 15 testing condition. |
|              |            |                                                                       |
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